PRODUCT SPECIFICATION

1.08" TFT LCD MODULE MODEL: YDP LCD I 108 S



- < <>> Preliminary Specification
- < <> Finally Specification

| CUSTOMER'S APPROVAL | | | | | | |
|---------------------|--|--|--|--|--|--|
| CUSTOMER : | | | | | | |
| SIGNATURE: DATE: | | | | | | |
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| | | | | | | |

| APPROVED | PM | PD | PREPARED |
|----------|----------------------------|------------------------|----------------------------|
| BY | REVIEWED | REVIEWED | BY |
| | TFT S. G. H 20240805 | TFT 周福云 20240805 | TFT D. F. G 20240805 |

knitter-switch

Revision History

| Revision | Date | Originator | Detail | Remarks |
|----------|------------|------------|-----------------|---------|
| 1.0 | 2024.08.05 | DFG | Initial Release | |
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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver IC and a backlight unit.

2. Module Parameter

| Features | Details | Unit |
|-----------------------------|--|------------|
| Display Size(Diagonal) | 1.08" | |
| LCD type | IPS TFT | |
| Display Mode | Transmissive /Normally Black | |
| Resolution | 128 RGB x 220 | Pixels |
| View Direction | FULL VIEW | Best Image |
| Module Outline | 16.12(H) x 29.76 (V) x 1.52(T) (Note1) | mm |
| Active Area | 13.824 (H) x 23.76(V) | mm |
| Pixel Size | 108(H) x 108 (V) | um |
| Pixel Arrangement | RGB Vertical Stripe | |
| Display Colors | 262K | |
| Interface | 4 Line SPI | |
| Driver IC | GC9203N | - |
| With or without touch panel | Without | |
| Operating Temperature | -20~70 | °C |
| Storage Temperature | -30~80 | °C |
| Weight | TBD | g |

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

V_{SS}=0V, Ta=25°C

| | | | V 33 V | V, 14 20 0 |
|-----------------------|--------|------|--------|------------|
| ltem | Symbol | Min. | Max. | Unit |
| Supply Voltage | VDD | -0.3 | 4.6 | V |
| Storage temperature | Tstg | -30 | +80 | °C |
| Operating temperature | Тор | -20 | +70 | °C |

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10° C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

| Item | Symbol | Min. | Тур. | Max. | Unit |
|---------------------------------------|-----------------|------|------|------|------|
| Supply Voltage | VDD | 2.5 | 2.8 | 3.3 | V |
| Operating Current for V _{DD} | I _{DD} | - | (2) | (3) | mA |

5. Backlight Characteristic

5.1. Backlight Characteristic

| Item | Symbol | Condition | Min. | Тур. | Max | Unit |
|-----------------------|------------------|-------------------------------------|-------|----------|-----|------|
| Backlight Voltage | VLED | Ta=25 °C, I _F =20mA/ LED | - | 3.0 | - | V |
| Backlight Current | ILED | Ta=25 °C, V _F =3.0V/ LED | - | 20 | - | mA |
| Power dissipation | PD | - | - | 60 | - | mW |
| Uniformity | Avg | - | - | 80 | - | % |
| LED working life(25℃) | - | | - | (30,000) | - | Hrs |
| Drive method | Constant current | | | | | |
| LED Configuration | | 1 WHIT | E LED | | | |

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness. The environmental conducted under ambient air flow, at Ta= 25 ± 2 °C,60%RH ±5 %, I_F=20mA/LED.

5.2. Backlighting circuit

OLEDK LEDA O-VF=3.0V IF=20mA

LED CIRCUIT DIAGRAM:

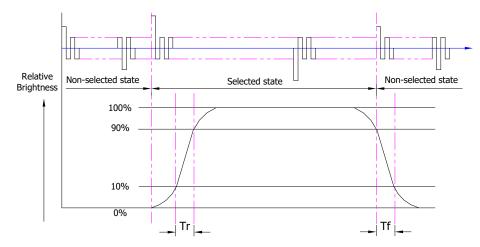
6. Optical Characteristics

6.1. Optical Characteristics

| | | | | | | Ta= | =25°C, VDD |)=2.8V |
|----------------------------------|---------------------------------------|--|------------------|------------------------------------|---------------|------|------------|--------|
| | ltem | | Symbol Condition | Condition | Specification | | | Unit |
| | nem | | | Min. | Тур. | Max. | Unit | |
| | Luminance on TFT(I_f =20mA/LED) | | | | | | | |
| Backlight On (Transmissive Mode) | | | Lv | Normally | 240 | 300 | - | cd/m² |
| | Contrast ratio | o(See 6.3) | CR | viewing angle | - | 800 | - | |
| | Response time (See 6.2) | | Tr+Tf | $\theta x = \varphi y = 0^{\circ}$ | - | 30 | 35 | ms |
| insmis | Chromoticity | $ \begin{array}{c} $ | XR | | - | TBD | - | |
| | | | YR | | - | TBD | - | |
| Tra | | | XG | | - | TBD | - | |
|) u | Transmissive | | | - | TBD | - | | |
| ut of | | Blue | Хв | | - | TBD | - | |
| lig | (000 0.0) | White | Υв | | - | TBD | - | |
| ack | | | Xw | | - | TBD | - | |
| 8 | | White | Yw | | - | TBD | - | |
| | Viewing | Horizontal | θx+ | | - | 80 | - | |
| | Angle | | θx- | Center CR≥10 | - | 80 | - | Deg. |
| | (See 6.4) | Vertical | φΥ+ | | - | 80 | - | Deg. |
| | (000 0.4) | ventical | φΥ- | | - | 80 | - | |

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

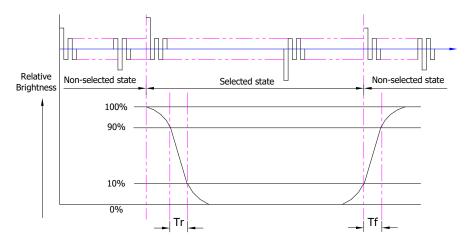


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

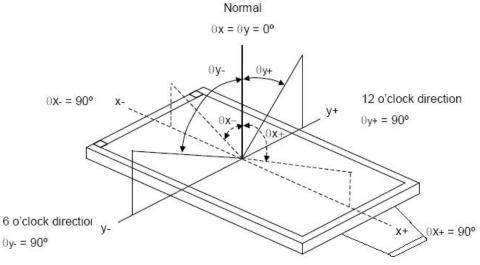
6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

| Measuring Equipment | Eldim or Equivalent |
|--------------------------|--------------------------|
| Measuring Point Diameter | 3mm//1mm |
| Measuring Point Location | Active Area centre point |
| Test pattern | A: All Pixels white |
| Test pattern | B: All Pixel black |
| Contrast setting | Maximum |

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

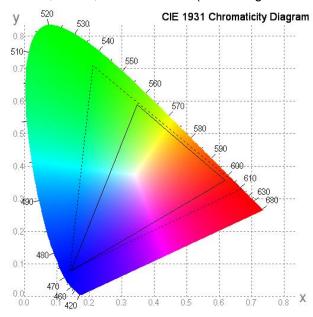
6.4. Definition of Viewing Angles



Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R, G, B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100% Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

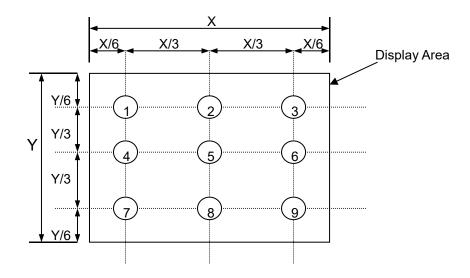


6.6. Definition of Surface Luminance, Uniformity and Transmittance

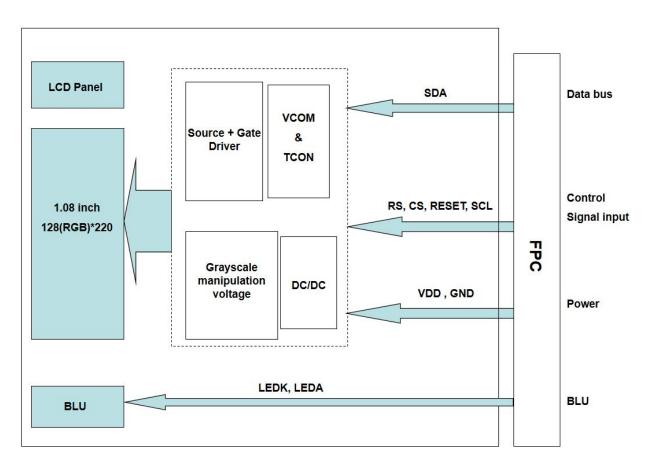
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance: L_V = average (L_{P1}:L_{P9})
- 6.6.2. Uniformity = Minimal (L_{P1}:L_{P9}) / Maximal (L_{P1}:L_{P9}) * 100%
- 6.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply



8. Interface Pins Definition

| No. | Symbol | Function | Remark |
|-----|--------|---|--------|
| 1 | NC | No connection | |
| 2 | NC | No connection | |
| 3 | SDA | SPI interface input/output pin | |
| 4 | SCL | This pin is used to be serial interface clock | |
| 5 | RS | Display data/command selection pin in 4-line serial interface | |
| 6 | RESET | This signal will reset the device, Signal is active low | |
| 7 | CS | Chip selection pin. Low enable, High disable. | |
| 8 | GND | Ground. | |
| 9 | NC | No connection | |
| 10 | VDD | Power supply | |
| 11 | LEDK | LED Cathode | |
| 12 | LEDA | LED Anode | |
| 13 | GND | Ground | |

9. AC Characteristics

TBD

10. Quality Assurance

10.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2. Standard for Quality Test

- 10.2.1. Sampling Plan:
 - GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5

Electrical functional: AQL 0.65.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3.Nonconforming Analysis & Disposition

- 10.3.1. Nonconforming analysis:
 - 10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.
 - 10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
 - 10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.
- 10.3.2. Disposition of nonconforming:
 - 10.3.2.1. Non-conforming product over PPM level will be replaced.
 - 10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

10.4.Agreement Items

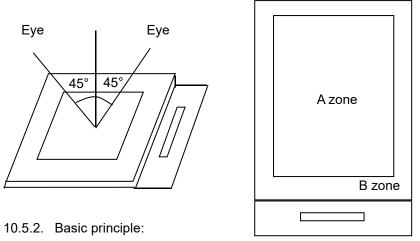
Shall negotiate with customer if the following situation occurs:

- 10.4.1. There is any discrepancy in standard of quality assurance.
- 10.4.2. Additional requirement to be added in product specification.
- 10.4.3. Any other special problem.

10.5. Standard of the Product Visual Inspection

- 10.5.1. Appearance inspection:
 - 10.5.1.1. The inspection must be under illumination about 1000 1500 lx, and the distance of view must be at 30cm ± 2cm.
 - 10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,



10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.10.5.2.2. New item must be added on time when it is necessary.

10.6.Inspection Specification

| No. | ltem | Criteria (Unit: mm) | | | | | |
|-----|--|--|-----------|---|------------------------------|---------------------------|--|
| 01 | Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect) | $\phi = (a + b)/2$ Distance between 2 of | defects : | Size | o≤0.15 o≤0.25 <φ al | lgı 2 no φ≤ | c. Qty nore 2 1 0 include 0.10 |
| 02 | Electrical Defect (Minor defect) | Bright dot Dark dot Total dot Mura Remark: 1. Bright dot caused | Not v | ay Area 0 I≤2 I≤2 risible throu | |) ≨2 ≨2 filters. | Note1 Note 2 to item 1. |

| 03 | Black and White line Scratch Foreign material (Line type) (Minor defect) | Length I $L \leq 2.5$ $L \leq 2.5$ I Distance between 2 | W Width W ≤ 0.03 $0.03 < W \leq 0.05$ $0.05 < W \leq 0.10$ 0.1 < W Total 2 defects should more that h the back of the display a | | tches |
|----|--|--|--|----------|-------|
| 04 | Glass Crack (Minor defect) | Crack is potential to | enlarge, any type is not a | allowed. | |

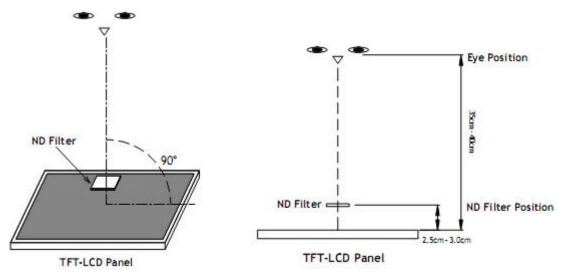
| 05 | Glass Chipping Pad Area: (Minor defect) | |
|----|--|---------------------------------------|
| | | Length and Width Acc. Qty |
| | | c > 3.0, b< 1.0 1 |
| | | c< 3.0, b< 1.0 3 |
| | | a <glass td="" thickness<=""></glass> |
| | b g c c | |

| | Glass Chipping Rear of Pad Area: (Minor defect) | | |
|----|--|--|-----------------------------|
| 06 | | Length and Width | Acc. Qty |
| | | c > 3.0, b< 1.0 | 1 |
| | | c< 3.0, b< 1.0 | 2 |
| | | c< 3.0, b< 0.5 | 4 |
| | to the second se | a <glass td="" thic<=""><td>kness</td></glass> | kness |
| | y ya | | |
| | Glass Chipping Except Pad Area: (Minor defect) | | |
| | ~ | Length and Width | Acc. Qty |
| | | c > 3.0, b< 1.0 | 1 |
| 07 | | c< 3.0, b< 1.0 | 2 |
| | | c< 3.0, b< 0.5 | 4 |
| | - Contraction of the second se | a <glass td="" thic<=""><td>kness</td></glass> | kness |
| | a↓_ | | |
| | Glass Corner Chipping: (Minor defect) | | |
| | | Length and Width | Acc. Qty |
| | | c < 3.0, b< 3.0 | Ignore |
| 08 | b a c c | a <glass td="" thic<=""><td>kness</td></glass> | kness |
| | Glass Burr: | | |
| | (Minor defect) | Length | Acc. Qty |
| | | F < 1.0 | |
| 09 | | Glass burr don't affect as dimension. | Ignore semble and module |
| | | | |

| FPC Defect: (Minor defect) w a | | 10.1 Dent, pinhole width a<w 3.<="" li=""> (w: circuitry width.) 10.2 Open circuit is unacceptable. 10.3 No oxidation, contamination and distortion. </w> | | nd distortion. |
|---|---|---|---|---|
| Bubble on Polarizer (Minor defect) | | Diameter φ≤0.20 0.20 <φ≤0.30 | Acc. Qty Ignore 4 1 None | |
| Dent on Polarizer (Minor defect) | | Diameter φ≤0.20 0.20 <φ≤0.30 0.30 <φ≤0.50 0.50 < φ | Acc. Qty Ignore 4 1 None | |
| Bezel | 13.1 No rust, distortion on the Bezel. 13.2 No visible fingerprints, stains or other contamination. | | | |
| PCB | 14.1 No distortion or contamination on PCB terminals. 14.2 All components on PCB must same as documented on the BOM/component layout. 14.3 Follow IPC-A-600F. | | | |
| Soldering | Follow IPC-A-610C standard | | | |
| Electrical Defect (Major defect) | The below defects must be rejected. 16.1 Missing vertical / horizontal segment, 16.2 Abnormal Display. 16.3 No function or no display. 16.4 Current exceeds product specifications. 16.5 LCD viewing angle defect. 16.6 No Backlight. 16.7 Dark Backlight. 16.8 Touch Panel no function | | | |
| | (Minor defect) W J Carlor Bubble on Polarizer (Minor defect) Dent on Polarizer (Minor defect) Bezel PCB Soldering Electrical Defect | (Minor defect) w | (Minor defect)10.1 Dent, pinhole f (w: circuitry width.) 10.2 Open circuit is 10.3 No oxidation, or 10.3 No oxidation, or 10.4 Dent, pinhole f (w: circuitry width.) 10.2 Open circuit is 10.3 No oxidation, or 10.3 No oxidation, or 10.4 Dent, pinhole f (w: circuitry width.) 10.2 Open circuit is 10.3 No oxidation, or 10.20 open circuit is 10.20 open circuit is 10.3 No oxidation, or 10.20 open circuit is 10.20 open | (Minor defect)10.1 Dent, pinhole width a <w 3.<br=""></w> (w: circuitry width.)10.1 Dent, pinhole width a <w 3.<br=""></w> (w: circuitry width.)10.2 Open circuit is unacceptable. 10.3 No oxidation, contamination atDiameterMinor defect)Dent on Polarizer (Minor defect)Defect (Major defect)PCBElectrical Defect (Major defect)Electrical Defect (Major defect)Ch on Statkinght. (6.4 Current exceeds product specifications. (6.5 LCD viewing angle defect. (6.6 No Backlight. (6.6 No Backlight. (6.7 Dark Backlight. |

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350 \text{ mm} \pm 50 \text{ mm}$.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350 \text{ mm} \pm 50 \text{ mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

11. Reliability Specification

| No | Item | Condition | Quantity | Criteria |
|----|------------------------------|---|----------|----------------------|
| 1 | High Temperature Operating | 70℃, 96Hrs | 2 | GB/T2423.2 -2008 |
| 2 | Low Temperature Operating | -20℃, 96Hrs | 2 | GB/T2423.1 -2008 |
| 3 | High Humidity Storage | 50℃, 85%RH, 96Hrs | 2 | GB/T2423.3 -2016 |
| 4 | High Temperature Storage | 80℃, 96Hrs | 2 | GB/T2423.2 -2008 |
| 5 | Low Temperature Storage | -30℃, 96Hrs | 2 | GB/T2423.1 -2008 |
| 6 | Thermal Cycling Test Storage | -10℃, 60min~60℃, 60min, 20 cycles. | 2 | GB/T2423.22 -2012 |
| 7 | Packing vibration | Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction. | - | GB/T5170.14 -2009 |
| 8 | Electrical Static Discharge | Air: \pm 4KV 150pF/330 Ω 5 times | 2 | GB/T17626.2 -2018 |
| | | Contact: \pm 2KV 150pF/330 Ω 5 times | | |
| 9 | Drop Test (Packaged) | Height:80 cm,1 corner, 3 edges, 6 surfaces. | - | GB/T2423.7- 2018 |

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

12. Precautions and Warranty

12.1.Safety

- 12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2.Handling

- 12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3.Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter.

12.4. Metal Pin (Apply to Products with Metal Pins)

- 12.4.1. Pins of LCD and Backlight
 - 12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering
 - 12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

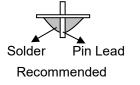
Maximum Solder Temperature: 370°C

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20℃

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting





- 12.4.2. Pins of EL
 - 12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.
 - 12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.
 - 12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

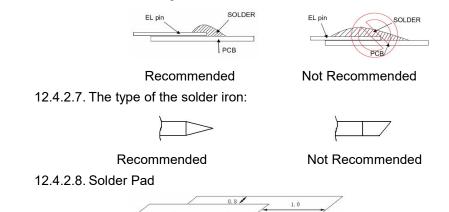
Recommended Solder Temperature: 270~290°C

Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

- 12.4.2.4. No horizontal press on the EL leads during soldering.
- 12.4.2.5. 180° bend EL leads three times is not allowed.

12.4.2.6. Solder Wetting



12.5.Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it may develop image sticking due to the TFT structure.

12.6.Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

12.7.Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

13. Packaging

TBD

14. Outline Drawing

